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[IXYS Corporation](#)

[IXTC180N085T](#)

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# IXYS

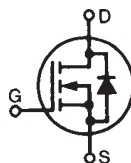
## TrenchMV™ Power MOSFET

## IXTC180N085T

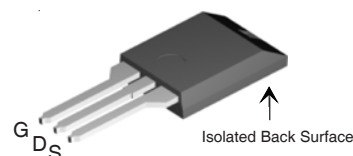
$V_{DSS} = 85V$   
 $I_{D25} = 110A$   
 $R_{DS(on)} \leq 6.1m\Omega$

**(Electrically Isolated Back) Surface)**

N-Channel Enhancement Mode  
 Avalanche Rated  
 Fast Intrinsic Rectifier



**ISOPLUS220**  
 **E153432**



G = Gate      D = Drain  
 S = Source

Symbol	Test Conditions	Maximum Ratings	
$V_{DSS}$	$T_J = 25^\circ C$ to $175^\circ C$	85	V
$V_{DGR}$	$T_J = 25^\circ C$ to $175^\circ C$ , $R_{GS} = 1M\Omega$	85	V
$V_{GSM}$	Transient	$\pm 20$	V
$I_{D25}$	$T_C = 25^\circ C$	110	A
$I_{LRMS}$	Lead Current Limit, RMS	75	A
$I_{DM}$	$T_C = 25^\circ C$ , Pulse Width Limited by $T_{JM}$	480	A
$I_A$	$T_C = 25^\circ C$	25	A
$E_{AS}$	$T_C = 25^\circ C$	1.0	J
$P_D$	$T_C = 25^\circ C$	150	W
$T_J$		-55 ... +175	$^\circ C$
$T_{JM}$		175	$^\circ C$
$T_{stg}$		-55 ... +175	$^\circ C$
$T_L$	1.6mm (0.062in.) from Case for 10s Plastic Body for 10 seconds	300 260	$^\circ C$ $^\circ C$
$V_{ISOL}$	50/60Hz, $t = 1$ minute, $I_{ISOL} < 1mA$ , RMS	2500	V
$M_d$	Mounting Force	11..65 / 2.5..14.6	N/lb.
<b>Weight</b>		2	g

### Features

- International Standard Package
- Silicon Chip on Direct-Copper Bond (DCB) Substrate
- Isolated Mounting Surface
- 2500V Electrical Isolation
- 175°C Operating Temperature
- Avalanche Rated
- Fast Intrinsic Rectifier
- Low  $R_{DS(on)}$

### Advantages

- Easy to Mount
- Space Savings
- High Power Density

### Applications

- Automotive
  - Motor Drives
  - DC/DC Conversion
  - 42V Power Bus
  - ABS Systems
- DC/DC Converters and Off-Line UPS
- Primary Switch for 24V and 48V Systems
- High Current Switching Applications
- Distributed Power Architectures and VRMs
- Electronic Valve Train Systems
- High Voltage Synchronous Rectifiers

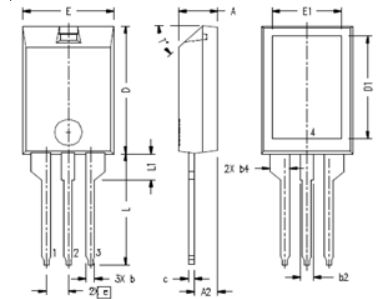
Symbol	Test Conditions ( $T_J = 25^\circ C$ Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
$BV_{DSS}$	$V_{GS} = 0V$ , $I_D = 250\mu A$	85		V
$V_{GS(th)}$	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$	2.0		4.0 V
$I_{GSS}$	$V_{GS} = \pm 20V$ , $V_{DS} = 0V$			$\pm 200$ nA
$I_{DSS}$	$V_{DS} = V_{DSS}$ , $V_{GS} = 0V$ <span style="float: right;"><math>T_J = 150^\circ C</math></span>			5 $\mu A$ 250 $\mu A$
$R_{DS(on)}$	$V_{GS} = 10V$ , $I_D = 25A$ , Notes 1, 2			6.1 m $\Omega$

# IXYS

# IXTC180N085T

Symbol	Test Conditions ( $T_J = 25^\circ\text{C}$ , Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
$g_{fs}$	$V_{DS} = 10\text{V}, I_D = 60\text{A}$ , Note 1	75	120	S
$C_{iss}$	$V_{GS} = 0\text{V}, V_{DS} = 25\text{V}, f = 1\text{MHz}$		8800	pF
$C_{oss}$			950	pF
$C_{rss}$			110	pF
$t_{d(on)}$	<b>Resistive Switching Times</b> $V_{GS} = 10\text{V}, V_{DS} = 0.5 \cdot V_{DSS}, I_D = 25\text{A}$ $R_G = 5\Omega$ (External)		32	ns
$t_r$			70	ns
$t_{d(off)}$			55	ns
$t_f$			65	ns
$Q_{g(on)}$		$V_{GS} = 10\text{V}, V_{DS} = 0.5 \cdot V_{DSS}, I_D = 25\text{A}$		170
$Q_{gs}$			40	nC
$Q_{gd}$			50	nC
$R_{thJC}$				1.0 °C/W
$R_{thCH}$		0.50		°C/W

### ISOPLUS220 (IXTC) Outline



1. Gate 2. Drain  
3. Source

Note: Bottom heatsink (Pin 4) is electrically isolated from Pins 1, 2, and 3.

SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.157	.197	4.00	5.00
A2	.098	.118	2.50	3.00
b	.035	.051	0.90	1.30
b2	.049	.065	1.25	1.65
b4	.093	.100	2.35	2.55
c	.028	.039	0.70	1.00
D	.591	.630	15.00	16.00
D1	.472	.512	12.00	13.00
E	.394	.433	10.00	11.00
E1	.295	.335	7.50	8.50
e	.100 BASIC		2.55 BASIC	
L	.512	.571	13.00	14.50
L1	.118	.138	3.00	3.50
T*			42.5*	47.5*

### Source-Drain Diode

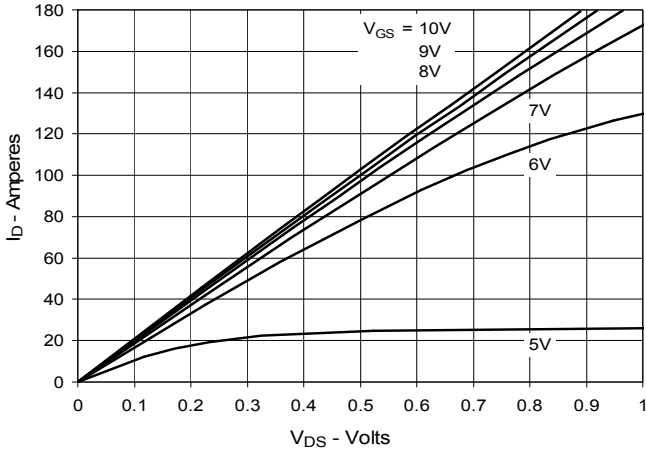
Symbol	Test Conditions ( $T_J = 25^\circ\text{C}$ , Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
$I_S$	$V_{GS} = 0\text{V}$			180 A
$I_{SM}$	Repetitive, Pulse Width Limited by $T_{JM}$			480 A
$V_{SD}$	$I_F = 25\text{A}, V_{GS} = 0\text{V}$ , Note 1			1.0 V
$t_{rr}$	$I_F = 90\text{A}, V_{GS} = 0\text{V}, -di/dt = 100\text{A}/\mu\text{s}$ $V_R = 40\text{V}$		63	ns
$I_{RM}$			4.1	A
$Q_{RM}$			129	nC

- Notes: 1. Pulse Test:  $t \leq 300 \mu\text{s}$ , Duty Cycle  $d \leq 2\%$ .  
2. Drain and Source Kelvin Contacts must be Located Less than 5 mm from the Plastic Body.

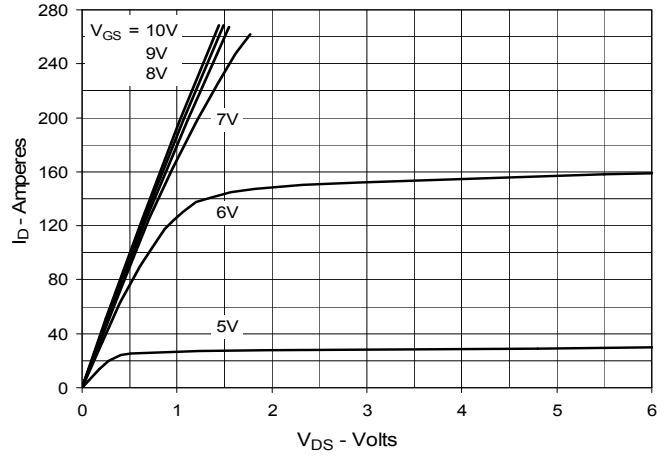
IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.

IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents:	4,835,592	4,931,844	5,049,961	5,237,481	6,162,665	6,404,065 B1	6,683,344	6,727,585	7,005,734 B2	7,157,338B2
	4,850,072	5,017,508	5,063,307	5,381,025	6,259,123 B1	6,534,343	6,710,405 B2	6,759,692	7,063,975 B2	
	4,881,106	5,034,796	5,187,117	5,486,715	6,306,728 B1	6,583,505	6,710,463	6,771,478 B2	7,071,537	

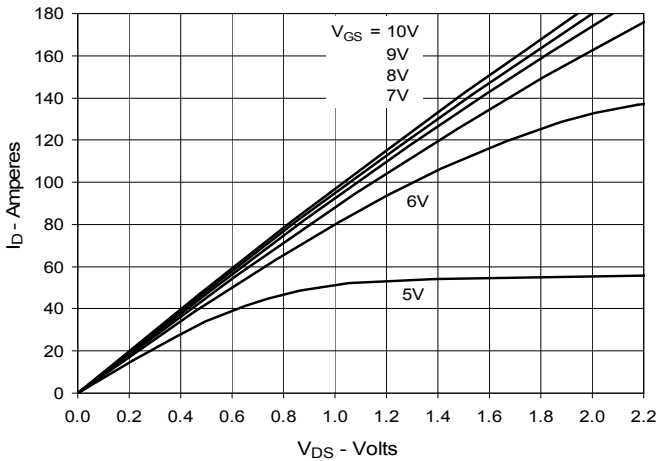
**Fig. 1. Output Characteristics @ 25°C**



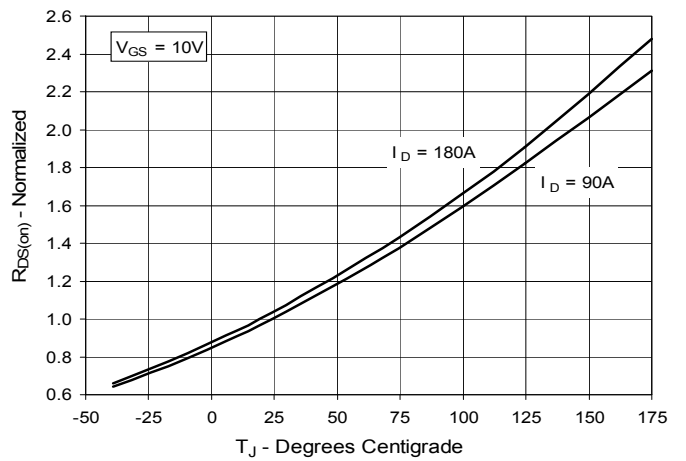
**Fig. 2. Extended Output Characteristics @ 25°C**



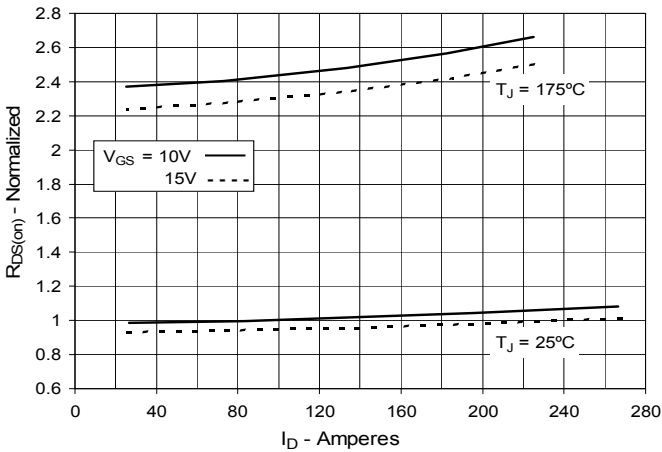
**Fig. 3. Output Characteristics @ 150°C**



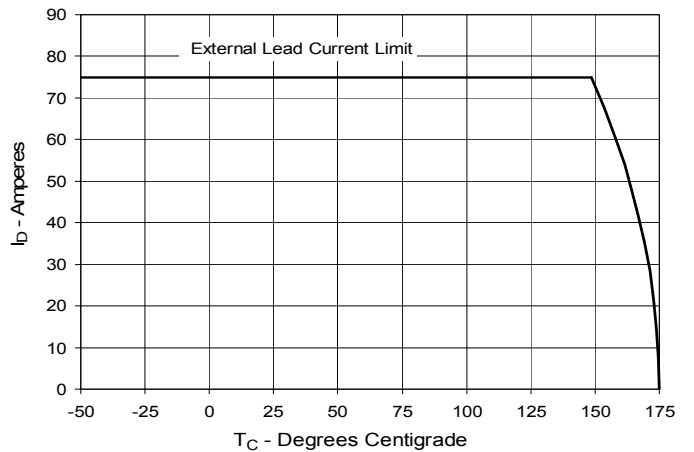
**Fig. 4.  $R_{DS(on)}$  Normalized to  $I_D = 90A$  Value vs. Junction Temperature**



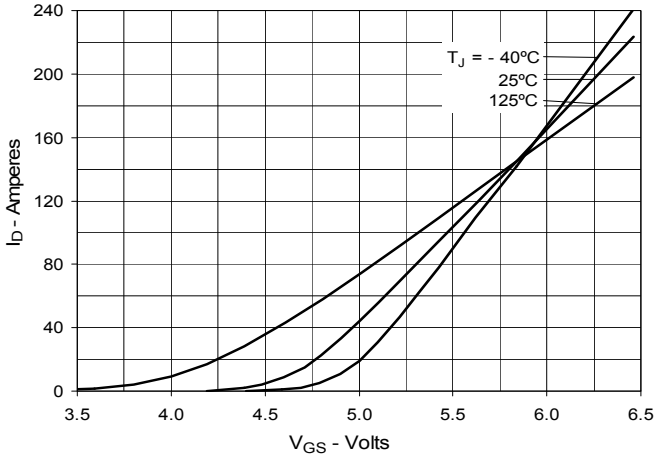
**Fig. 5.  $R_{DS(on)}$  Normalized to  $I_D = 90A$  Value vs. Drain Current**



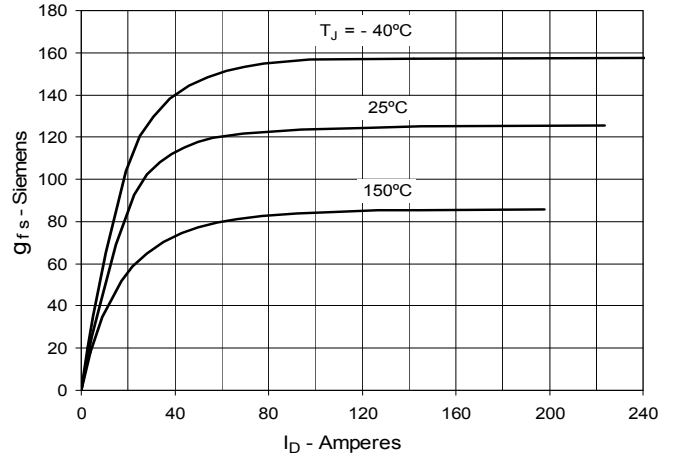
**Fig. 6. Drain Current vs. Case Temperature**



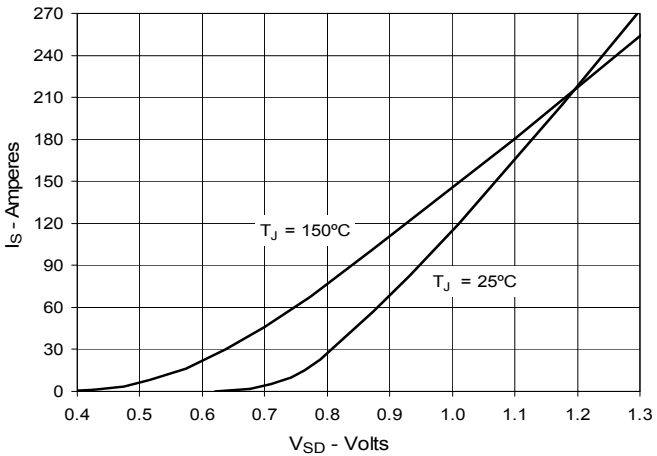
**Fig. 7. Input Admittance**



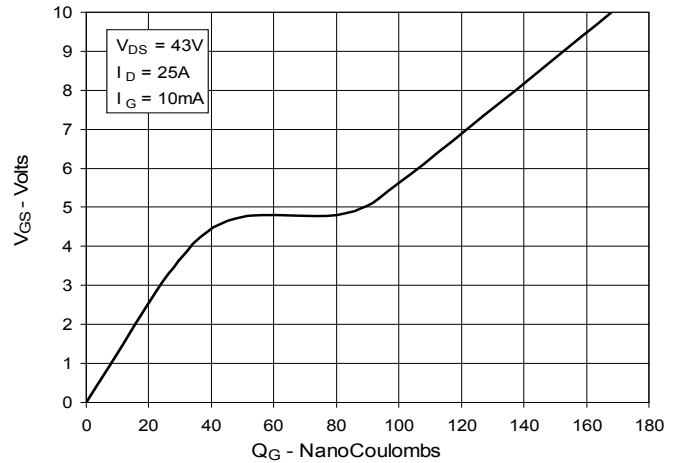
**Fig. 8. Transconductance**



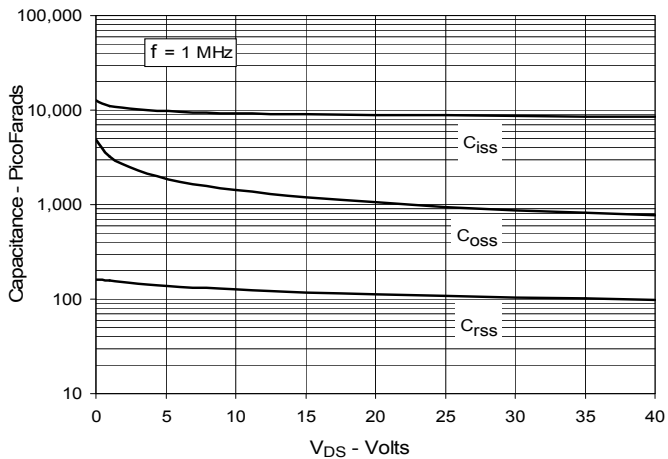
**Fig. 9. Forward Voltage Drop of Intrinsic Diode**



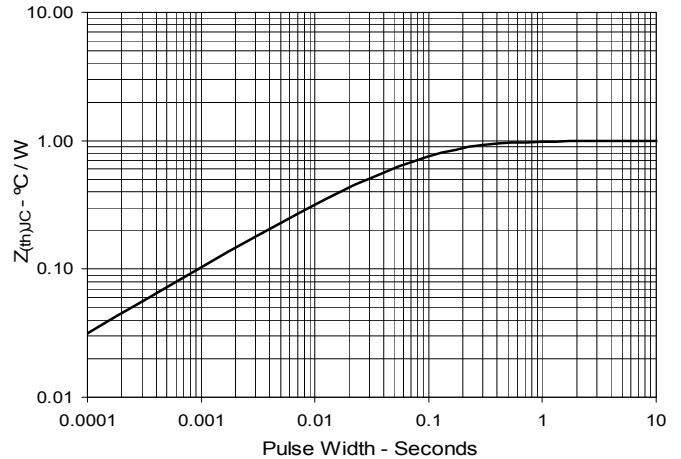
**Fig. 10. Gate Charge**



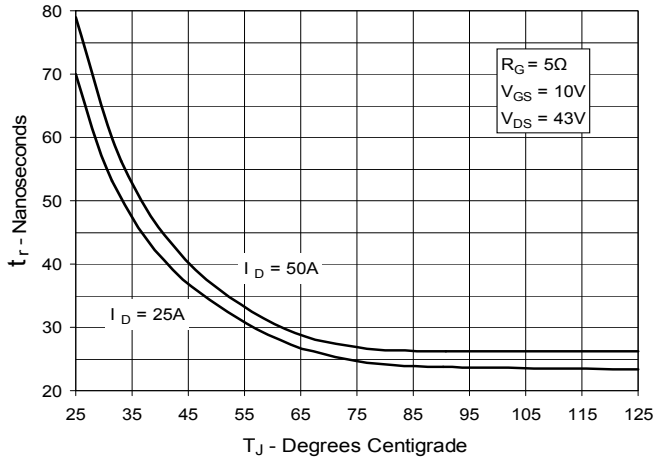
**Fig. 11. Capacitance**



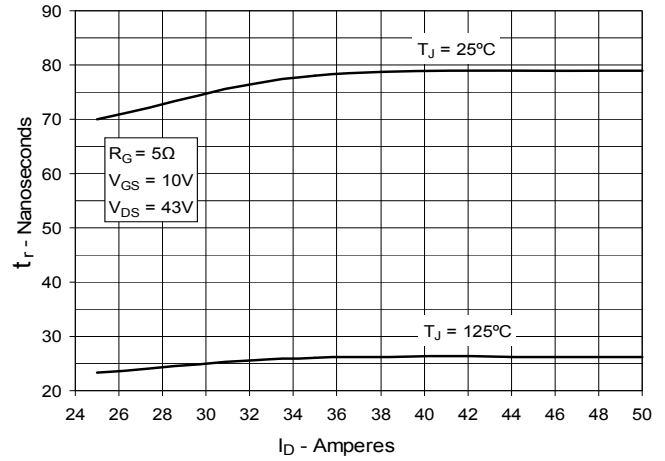
**Fig. 12. Maximum Transient Thermal Impedance**



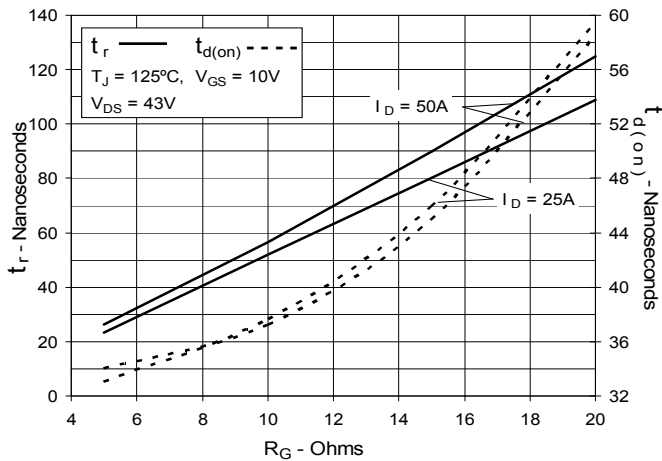
**Fig. 13. Resistive Turn-on**  
Rise Time vs. Junction Temperature



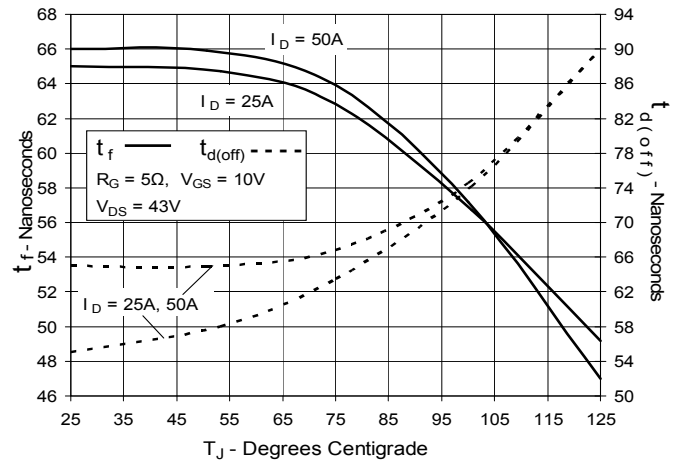
**Fig. 14. Resistive Turn-on**  
Rise Time vs. Drain Current



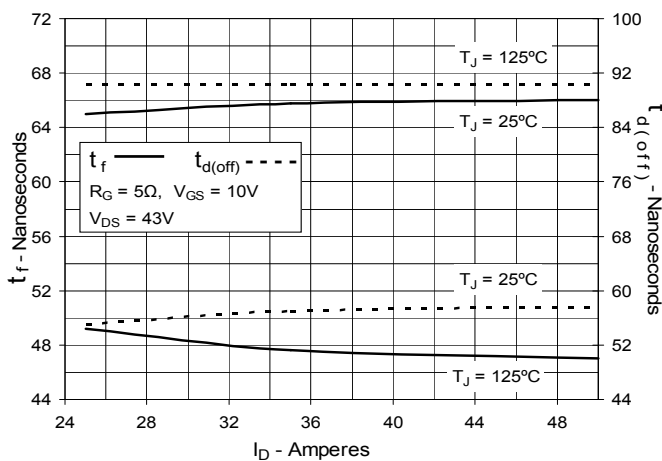
**Fig. 15. Resistive Turn-on**  
Switching Times vs. Gate Resistance



**Fig. 16. Resistive Turn-off**  
Switching Times vs. Junction Temperature



**Fig. 17. Resistive Turn-off**  
Switching Times vs. Drain Current



**Fig. 18. Resistive Turn-off**  
Switching Times vs. Gate Resistance

